



FORTRON® 0214

Polyphenylene sulfide

0214 is an unfilled grade exhibiting good melt strength. This grade demonstrates excellent heat and chemical resistance. It can be extruded to produce multi-filaments. Due to the excellent balance of flow and melt strength, this product is occasionally used for injection molding parts. Available standard in powder (0214B1), pellet (0214P1) and crystallized pellet (0214C1) form.

Prod	LICT	info	rm	ation
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Resin Identification	PPS >PPS<		ISO 1043 ISO 11469
Part Marking Code	>٢٢٥<		150 1 1409
Rheological properties			
Moulding shrinkage, parallel	1.2	%	ISO 294-4, 2577
Moulding shrinkage, normal	1.5	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	3800	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min		MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	3	%	ISO 527-1/-2
Flexural modulus	3750	MPa	ISO 178
Flexural strength	-	MPa	ISO 178
Izod notched impact strength, 23°C		kJ/m²	ISO 180/1A
Izod impact strength, 23°C		kJ/m²	ISO 180/1U
Hardness, Rockwell, M-scale	95		ISO 2039-2
Poisson's ratio	0.36 ^[C]		
[C]: Calculated			
Thermal properties			
Melting temperature, 10°C/min	280	°C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	90	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	110	°C	ISO 75-1/-2
Temperature of deflection under load, 8 MPa	95	°C	ISO 75-1/-2
Coefficient of linear thermal expansion	52	E-6/K	ISO 11359-1/-2
(CLTE), parallel			
Coefficient of linear thermal expansion (CLTE), normal	53	E-6/K	ISO 11359-1/-2
Specific heat capacity of melt	1830	J/(kg K)	ISO 22007-4
Electrical properties			
Relative permittivity, 1000Hz	3.2		IEC 62631-2-1
Volume resistivity		Ohm.m	IEC 62631-3-1
Electric strength		kV/mm	IEC 60243-1
Comparative tracking index	125		IEC 60112
Arc Resistance	124	S	UL 746B

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Physical/Other properties

Water absorption, 2mm	0.02 %	Sim. to ISO 62
Water absorption, Immersion 24h	0.03 %	Sim. to ISO 62
Density	1350 kg/m ³	ISO 1183
Density of melt	1150 kg/m ³	

Injection

Drying Temperature110 °CDrying Time, Dehumidified Dryer2 - 4 hProcessing Moisture Content≤0.02 %Melt Temperature Optimum315 °CMin. melt temperature275 °CMax. melt temperature320 °CScrew tangential speed0.2 - 0.3 m/sMold Temperature Optimum150 °CMin. mould temperature135 °CMax. mould temperature160 °CHold pressure range30 - 70 MFBack pressure3 MF	Drying Recommended	yes	
Processing Moisture Content≤0.02 %Melt Temperature Optimum315 °CMin. melt temperature275 °CMax. melt temperature320 °CScrew tangential speed0.2 - 0.3 m/sMold Temperature Optimum150 °CMin. mould temperature135 °CMax. mould temperature160 °CHold pressure range30 - 70 MF	Drying Temperature	110	°C
Melt Temperature Optimum315°CMin. melt temperature275°CMax. melt temperature320°CScrew tangential speed0.2 - 0.3m/sMold Temperature Optimum150°CMin. mould temperature135°CMax. mould temperature160°CHold pressure range30 - 70MF	Drying Time, Dehumidified Dryer	2 - 4	h
Min. melt temperature275 °CMax. melt temperature320 °CScrew tangential speed0.2 - 0.3 m/sMold Temperature Optimum150 °CMin. mould temperature135 °CMax. mould temperature160 °CHold pressure range30 - 70 MF	Processing Moisture Content	≤0.02	%
Max. melt temperature320°CScrew tangential speed0.2 - 0.3m/sMold Temperature Optimum150°CMin. mould temperature135°CMax. mould temperature160°CHold pressure range30 - 70MF	Melt Temperature Optimum	315	°C
Screw tangential speed0.2 - 0.3m/sMold Temperature Optimum150°CMin. mould temperature135°CMax. mould temperature160°CHold pressure range30 - 70MF	Min. melt temperature	275	°C
Mold Temperature Optimum Min. mould temperature Max. mould temperature Hold pressure range 150 °C 135 °C 160 °C 160 °C 160 °C	Max. melt temperature	320	°C
Min. mould temperature135 °CMax. mould temperature160 °CHold pressure range30 - 70 MF	Screw tangential speed	0.2 - 0.3	m/s
Max. mould temperature 160 °C Hold pressure range 30 - 70 MF	Mold Temperature Optimum	150	°C
Hold pressure range 30 - 70 MF	Min. mould temperature	135	°C
	Max. mould temperature	160	°C
Rack pressure 3 MF	Hold pressure range	30 - 70	MPa
Daok prosoure 0 Mil	Back pressure	3	MPa
Ejection temperature 192 °C	Ejection temperature	192	°C

Characteristics

Processing Injection Moulding, Film Extrusion, Extrusion, Other Extrusion

Delivery form Pellets, Powder

Special characteristics Heat stabilised or stable to heat, Chemical resistant

Additional information

Injection molding Preprocessing

In spite of the minimum moisture absorption a drying of FORTRON is necessary. Predrying in a dehumidified air dryer at 120 degC/3-4 hours is recommended.

Processing

On injection molding machines with 15-25 D long three-section screws, are usual in the trade, the unreinforced FORTRON is processable. A shut-off nozzle is recommended.

Melt temperature 310-320 degC

Mold wall temperature at least 140 degC

A medium injection rate is normally preferred. All mold cavities must be effectively vented.

Processing Notes Pre-Drying

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FORTRON® 0214

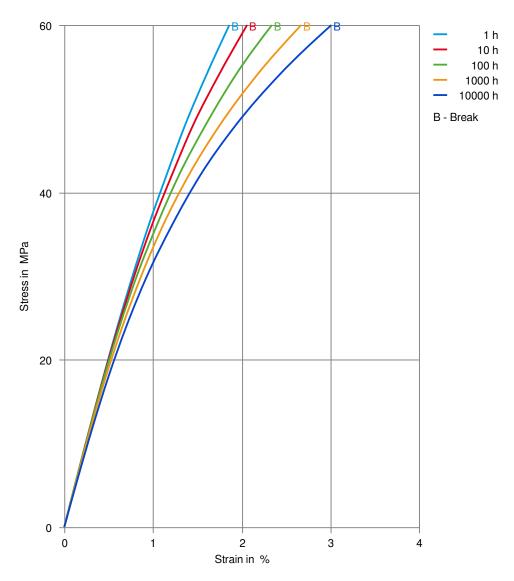
Polyphenylene sulfide

FORTRON should in principle be predried. Because of the necessary low maximum residual moisture content the use of dry air dryers is recommended. The dew point should be =< - 30° C. The time between drying and processing should be as short as possible.

Storage

For subsequent storage the material should be stored dry in the dryer until processed (<= 60 h).

Stress-strain (isochronous) 23°C



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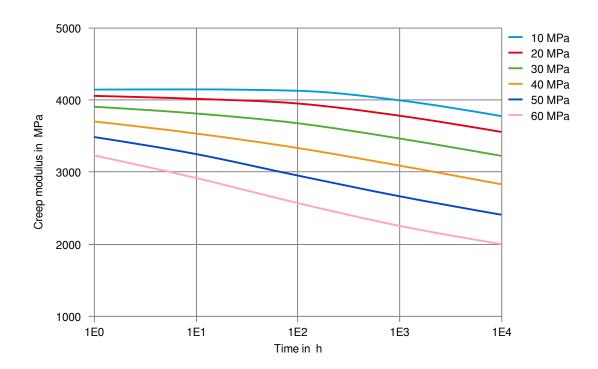
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Creep modulus-time 23°C



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